Interference Search

EAST Search History application # 10/798,398.

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Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp	
L6	1	((component or chip or device or IC or integrated adj circuit or die or semiconduct\$4 adj element) with (adhesive) with (conductive) with (pad or terminal or land) with (size or cross\$1section\$2) with (board or substrate)).clm.	US-PGPUB	OR	ON	2006/10/17 16:55	
L7	5	((component or chip or device or IC or integrated adj circuit or die or semiconduct\$4 adj element) same (adhesive) same (conductive) same (pad or terminal or land) same (size or cross\$1section\$2) same (board or substrate)).clm.	US-PGPUB	OR	ON	2006/10/17 13:53	
L8	4	7 not 6	US-PGPUB	OR	ON	2006/10/17 13:54	
L9	163	((component or chip or device or IC or integrated adj circuit or die or semiconduct\$4 adj element) and (adhesive) and (conductive) and (pad or terminal or land) and (size or cross\$1section\$2) and (board or substrate)).clm.	US-PGPUB	OR	ON	2006/10/17 13:54	
L10	158	9 not (7 or 6)	US-PGPUB	OR	ON	2006/10/17 16:55	
L11	7	((component or chip or device or IC or integrated adj circuit or die or semiconduct\$4 adj element) with (adhesive) with (pad or terminal or land) with (size or cross\$1section\$2) with (board or substrate)).clm.	US-PGPUB	OR	ON	2006/10/17 16:56	
L12	3	11 not (9 or 7 or 6)	US-PGPUB	OR	ON	2006/10/17 16:56	
L13	17	((component or chip or device or IC or integrated adj circuit or die or semiconduct\$4 adj element) same (adhesive) same (pad or terminal or land) same (size or cross\$1section\$2) same (board or substrate)).clm.	US-PGPUB	OR	ON	2006/10/17 16:56	
L14	6	13 not (11 or 9 or 7 or 6)	US-PGPUB	OR	ON	2006/10/17 17:04	
L15	0	((electronic adj circuit adj device) with (board or substrate) with (resin) with (land or pad or terminal) with (size or cross\$1section) with (conductive adhesive or paste)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/17 17:02	

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L18	5	((component or chip or device or IC or integrated adj circuit or die or semiconduct\$4 adj element) with (board or substrate) with (resin) with (land or pad or terminal) with (size or cross\$1section) with (conductive adhesive or paste)).clm.	US-PGPUB	OR	ON	2006/10/17 17:03
L19	2	18 not (13 or 11 or 9 or 7 or 6)	US-PGPUB	OR	ON	2006/10/17 17:04
L20	3	((electronic adj component) with (terminal or land or pad) with (size or cross\$1section\$2) with (adhesive)). clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/17 17:06